

## ROL0 No-Clean Tack Flux in a 3cc/3g syringe w/plunger & tips

### Product Highlights

**More Robust, Higher Activity, Better Wetting, No-Clean**  
 Ideal for all rework, solder, de-solder and reflow applications  
 Non-corrosive, non-conductive  
 Tack flux will not run all over PCB when applied  
 Has a pleasant odor  
 Excellent wetting  
 Easily cleaned with isopropyl alcohol (IPA)  
 Attachment of BGA spheres  
 Soldering flip chip components  
 Long stencil life  
 Wide process window  
 Clear residue  
 Can be used with Leaded and Lead-Free applications  
**RoHS 3 and REACH compliant**



### Specifications

Flux Type:	Synthetic No-Clean (for Leaded and Lead-Free applications)
Flux Classification:	ROL0
Flux Activation Temperature:	140°C (284°F)
Packaging:	3cc/3g Luer Lock Syringe w/plunger & tips
Shelf Life:	Refrigerated >24 months, Unrefrigerated >24 months

### Stencil Life

>8 hours @ 20-50% RH 22-28°C (72-82°F)  
 >4 hours @ 50-70% RH 22-28°C (72-82°F)

### Stencil Cleaning

Automated stencil cleaning systems for both stencil and misprinted boards. Manual cleaning using isopropyl alcohol (IPA).

### Storage and Handling

Store refrigerated or at room temperature 3-25°C (37-77°F). Do not freeze. Allow 4 hours for flux to reach an operating temperature of 20-25°C (68-77°F) before use.

### Transportation

This product has no shipping restrictions. Shipping below 0°C (32°F) or above 25°C (77°F) for normal transit times by ground or air will not impact this product's stated shelf life.

### Conforms to the following Industry Standards:

J-STD-004B, Amendment 1 (Solder Fluxes):	Yes
RoHS 3 Directive (EU) 2015/863:	Yes